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3, 4

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Application

- $\cdot \, \text{Motor drive}$
- · Converter
- · Photovoltaics, wind power generation.

Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

Construction

This product is a chopper module consisting of SiC-UMOSFET and SiC-SBD from ROHM.

Circuit diagram

10 °

11 °

7 0-

9 (N. C) C

8 C

6 5

*Do not connect anything to NC pin.

NTC

•Dimensions & Pin layout (Unit : mm)



	$(1_j - 20.0)$				
Parameter	Symbol	Conditions Ratings		Unit	
Drain - Source Voltage	V _{DSS}	G-S short	1200 1200		
Repetitive Reverse Voltage	V _{RRM}	Clamp diode			
Gate - Source Voltage (+)	V_{GSS}	D-S short	22	V	
Gate - Source Voltage (-)	V _{GSS} D-S short		-4		
G - S Voltage (t _{surge} <300nsec)	$V_{GSSsurge}$	D-S short	-4 to 26		
	Ι _D	DC(Tc=60°C) VGS=18V	576		
Drain Current Note 1)	Ι _D	DC(Tc=50°C) VGS=18V	600		
	I _{DRM}	Pulse (Tc = 60°C) 1ms VGS=18V $_{Note 2)}$	1200		
	I _S	DC(Tc=60°C) VGS=18V	576		
Source Current	I _S	DC(Tc=50°C) VGS=18V	600	А	
Source Current Note 1)	I _{SRM}	I _{SRM} Pulse (Tc = 60°C) 1ms VGS=18V _{Note 2)}		-	
	I _{SRM} Pulse (Tc = 60°C) 1ms VGS=0V _{Note 2)}		1200		
Forward Current	١ _F	$DC(Tc = 60^{\circ}C)$	600		
(clamp diode) Note 1)	I _{FRM}	Pulse (Tc = 60° C) 1ms _{Note 2})	1200		
Total Power Dissipation Note 3)	Ptot	Tc = 25°C 2460		W	
Max Junction Temperature	Tjmax		175		
Junction Temperature	Тјор		-40 to 150	°C	
Storage Temperature	Tstg		-40 to 125		
Isolation Voltage	Visol	Terminals to baseplate f = 60Hz AC 1 min. 2500		Vrms	
Mounting Torque		Main Terminals : M6 screw	4.5	NI	
Mounting Torque	-	Mounting to heat sink M5 screw	3.5	N∙m	

●Absolute maximum ratings (T_i = 25°C)

Note 1) Case temperature (Tc) is defined on the surface of base plate just under the chips.

Note 2) Repetition rate should be kept within the range where temperature rise if die should not exceed Tjmax.

Note 3) Tj is less than 175°C.

Example of acceptable VGS waveform





•Electrical characteristics (T_j=25°C)

Denemeter	Ourseland	Conditions		Ratings			
Parameter	Symbol			Min.	Тур.	Max.	Unit
On-state static Drain-Source Voltage	Vds(on)	ID=600A,VGS=18V Tj=	Tj=25°C	—	1.8	2.4	V
			Tj=125°C	_	2.6	_	
			Tj=150°C	-	2.9	4.1	
Drain Cutoff Current	ldss	VDS=1200V,VGS=0V		_	_	10	uA
Forward Voltage	VF	I _F =600A	Tj=25°C	_	1.8	2.2	V
			Tj=125°C	_	2.4	_	
			Tj=150°C	-	2.6	3.2	
Reverse current	IRRM	Clamp diode		—	_	4	mA
Gate-Source Threshold Voltage	Vcs(th)	VDS=10V,ID=182mA		2.7	_	5.6	V
Gate-Source	looo	VGS=22V,VDS=0V VGS=-4V,VDS=0V		-	—	0.5	μA
Leak Current	lgss			-0.5	—	_	
Switching Characteristics	td(on)	Vgs(on)=18V、Vgs(off)=0V Vps=600V			70	_	
	tr				50		
	trr	Iɒ=600A Rɡ(on)=0.2 ohm, Rɡ(off)=0.2 ohm Inductive load		1	20		ns
	td (off)				240	-	
	tf			-	65	_	
Input Capacitance	Ciss	VDS=10V,VGS=0V,200kHz			28	_	nF
Gate Registance	RGint	Tj=25°C			1.4	_	Ω
NTC Rated Resistance	R25			_	5.0	_	kΩ
NTC B Value	B50/25				3370	_	К
Stray Inductance	Ls			_	10.0	_	nH
Creepage Distance	-	Terminal to heat sink		1	16.7		mm
		Terminal to terminal			16.7	-	mm
Clearance Distance	-	Terminal to heat sink			12.0	—	mm
		Terminal to terminal			11.0	—	mm
Junction-to -Case	Dth(i_o)	UMOSFET(1/2 module) Note 4)			-	61	°C/kW
Thermal Resistance	Rth(j-c)	SBD(1/2 module) Note 4)		I	—	61	
Case-to -heat sink Thermal Resistance	Rth(c-f)	Case to heat sink, per 1 module. Thermal grease applied. Note 5)			15	_	

- Note 4) Measurement of Tc is to be done at the point just under the chip.
- Note 5) Typical value is measured by using thermally conductive grease of λ =0.9W/(m·K).
- Note 6) SiC devices have lower short cuicuit withstand capability due to high current density. Please be advised to pay careful attention to short cuicuit accident and try to adjust protection time to shutdown them as short as possible.
- Note 7) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.







Fig.1 Output characteristic 25°C (TYP)





Fig.4 Ron vs Tj characteristic (TYP)







Fig.7 Drain Current vs Gate Voltage (TYP)



Fig.8 Drain Current vs Gate Voltage (TYP)







Fig.11 Switching time vs drain current at 150°C (TYP)



Fig.12 Switching loss vs drain current at 25°C (TYP)









Fig.16 Recovery characteristic vs drain current at 125°C (TYP)







Fig.18 Switching time vs gate resistance at 25°C (TYP)

Fig.20 Switching time vs gate resistance at 150°C (TYP)



Fig.19 Switching time vs gate resistance



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at 125°C (TYP) 120 Eoff V_{DS}=600V I_D=600A 100 V_{GS}(on)=18V Eon V_{GS}(off)=0V INDUCTIVE LOAD Switching loss (mJ) 80 60 40 20 Err 0 0.1 1 10 100 Gate resistance RG (Ω)

Fig.22 Switching loss vs gate resistance

Fig.23 Switching loss vs gate resistance at 150°C (TYP) 120 Eoff V_{DS}=600V I_D=600A 100 V_{GS}(on)=18V V_{GS}(off)=0V Switching loss (mJ) INDUCTIVE LOAD 80 Eon 60 40 20 Err 0 0.1 10 100 1 Gate resistance RG (Ω)

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Fig.25 Gate charge characteristic (TYP)





Fig.26 Transient thermal impedance (TYP)



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